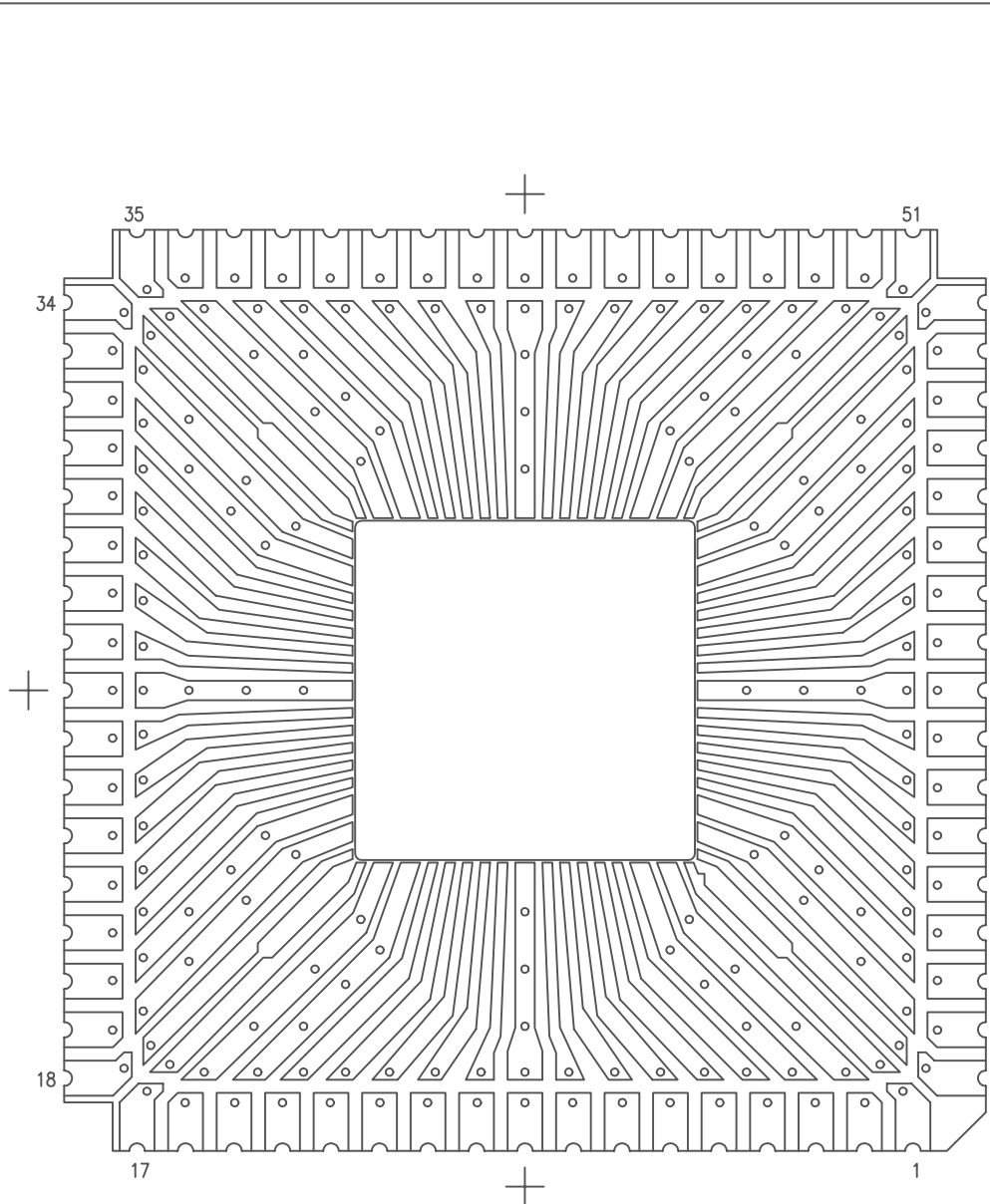


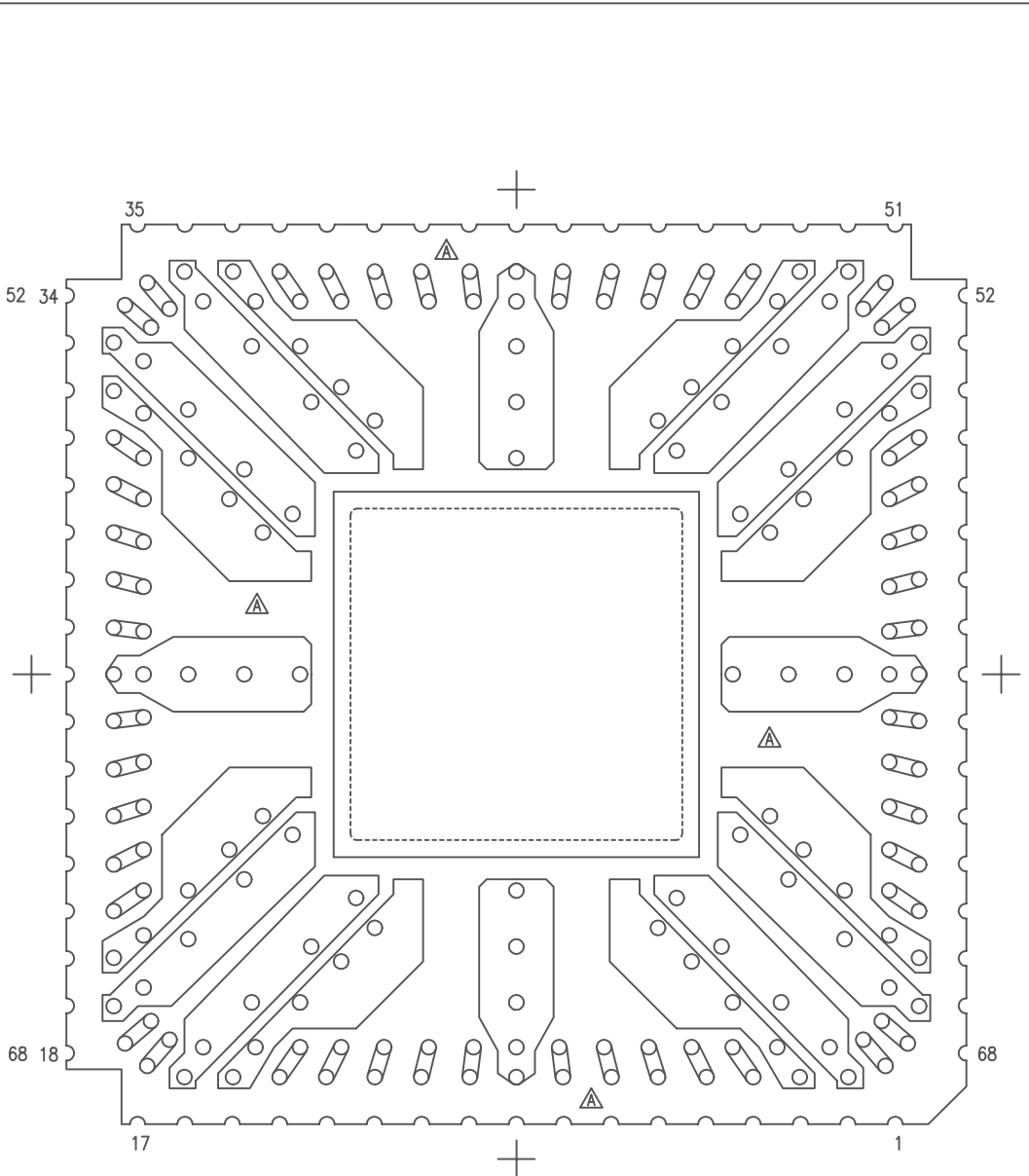
- NOTES:
- DIE ATTACH PAD SHALL BE ISOLATED FROM ALL LEADS. (ZERO GROUND)
  - ALL EXPOSED METALLIZED AREA AND LEAD SHALL BE GOLD PLATED 80 MICRO INCHES MIN. THICKNESS OVER 100 MICRO INCHES NOM. NICKEL OVER REFRACTORY METALLIZATION.
  - FLATNESS PERTAINS TO METALLIZED PADS ONLY.
  - LEAD TO LEAD LEAKAGE SHALL NOT EXCEED 10 NANO AMPS 100V D.C.
  - LEAD RESISTANCE : POWER LEADS 0.08 OHM (No.2,3,9,15,16,19,20,26,32,33,36, 37,43,49,50,53,54,60,66,67.)  
SIGNAL LEADS 0.3 OHM (OTHER LEADS)
  - CAPACITANCE : SIGNAL LEAD TO SIGNAL LEAD :1.0pF AT 1000Hz.  
POWER LEAD TO SIGNAL LEAD :2.0pF AT 1000Hz.

PART No.	HEAT SINK METALLIZATION	
01	WITH	HKO-68FZ
02	WITHOUT	

MODIFICATIONS				TOLERANCES UNLESS OTHERWISE SPECIFIED				DRAWN		CHECKED		APPROVED		DATE	
CHANGED LEAD FRAME				± .005				T.Y.		T.I.		K.I.		2-24-86	
CHANGE				THIRD ANGLE PROJECTION				DATE		DRAWN		CHECKED		APPROVED	
				MATERIAL				NAME		SCALE		DRAWING NO.		SHEET	
				KYOCERA A-440				68 CQFP (.350 SQ. CAV.)		6/1		PB-F86086-A		1/2	
				KYOCERA CORPORATION				KYOCERA		KYOCERA CORPORATION		KYOTO JAPAN			
				HKO-68FZ											



WIRE BONDING AREA



DIE ATTACH AREA

MODIFICATIONS						NAME	68 CQFP (.350 SQ. CAV.)	TOLERANCES:	DRAWN	CHECKED	APPROVED	DATE			
						SCALE	10/1	UNLESS OTHERWISE SPECIFIED	T.Y.	T.I.	K.I.	2-24-'86			
						MATERIAL		THIRD ANGLE PROJECTION							
	△ CHANGED PATTERN			4-10-'86	T.Y.	T.I.									
	CHANGE			DATE	DRAWN	CHECKED	APPROVED		KYOCERA CORPORATION KYOTO JAPAN			DRAWING NO.	PB-F86086-A	SHEET	2/2